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Docket No.
Jin 210-33-6

TRANSMITTAL OF FORMAL DRAWINGS

In Re Application Of: S. Jin et al.



Serial No.

Filing Date

Receiving No.

Examiner

Art Unit

09/769,193

01/25/2001

Jennifer Doan

2874

Invention: **Resiliently Packaged MEMs Device and Method for Making Same**

Address to:

Assistant Commissioner for Patents
Washington, D.C. 20231

Transmitted herewith are:

11 sheets of formal drawing(s) for this application.

☒ Each sheet of drawing indicates the identifying indicia suggested in 37 CFR Section 1.84(c).

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Dated: 6/17/2002

I certify that this document and attached formal drawings
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FIG. 1A

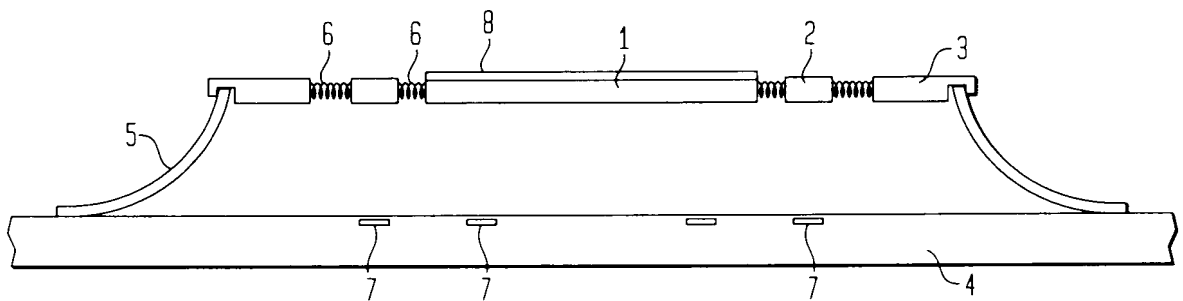


FIG. 1B

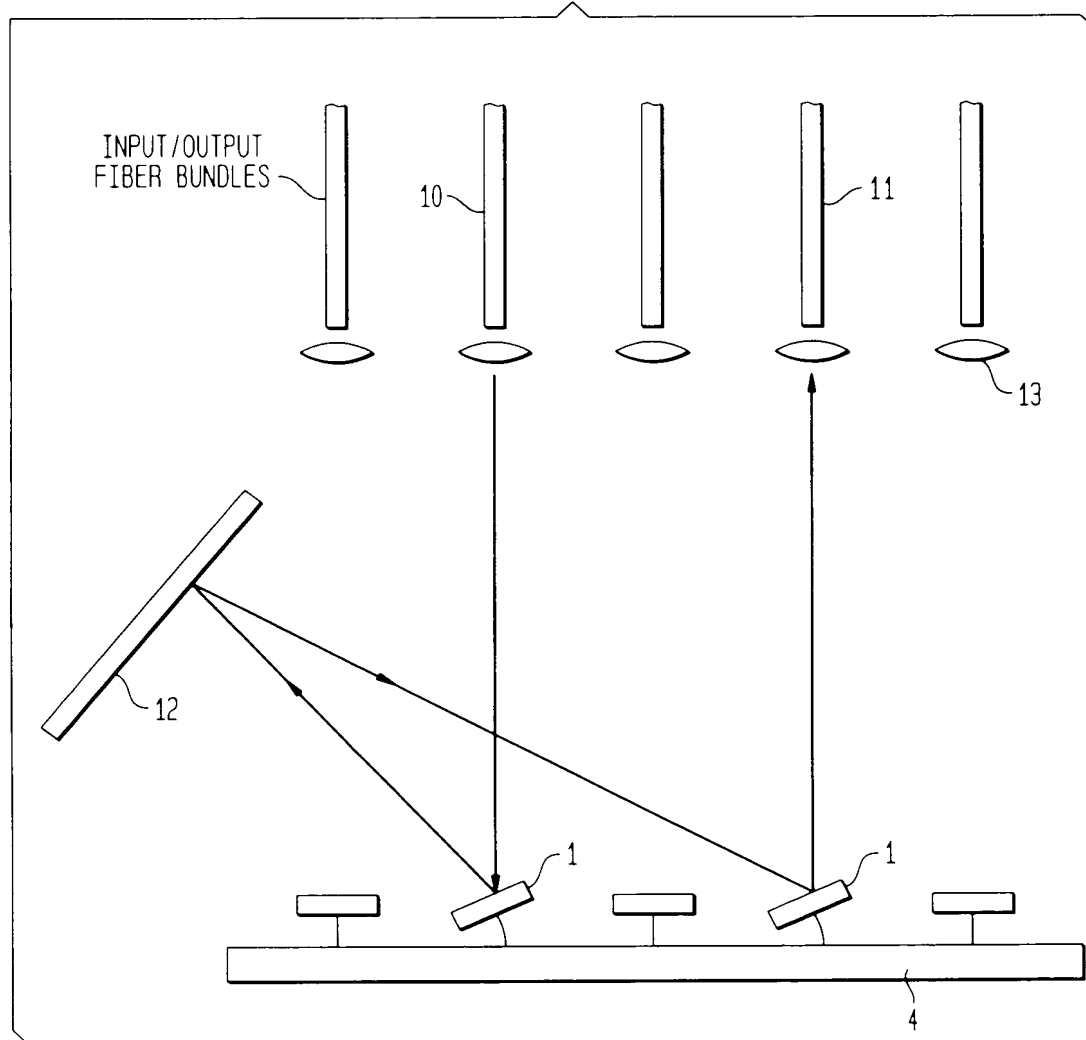


FIG. 2

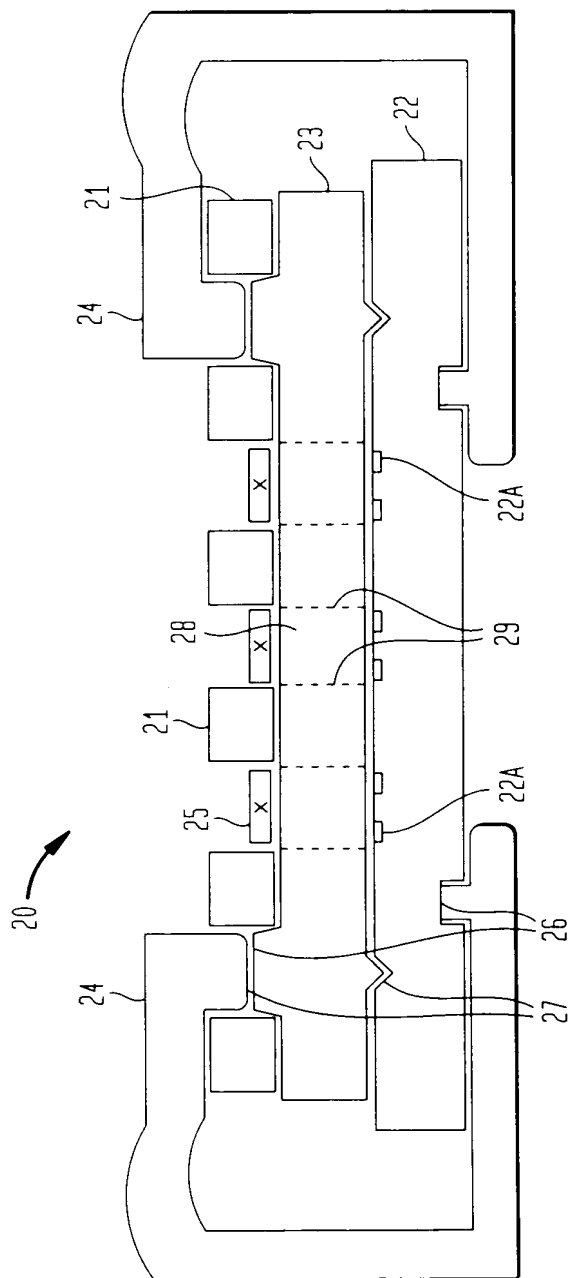


FIG. 3A

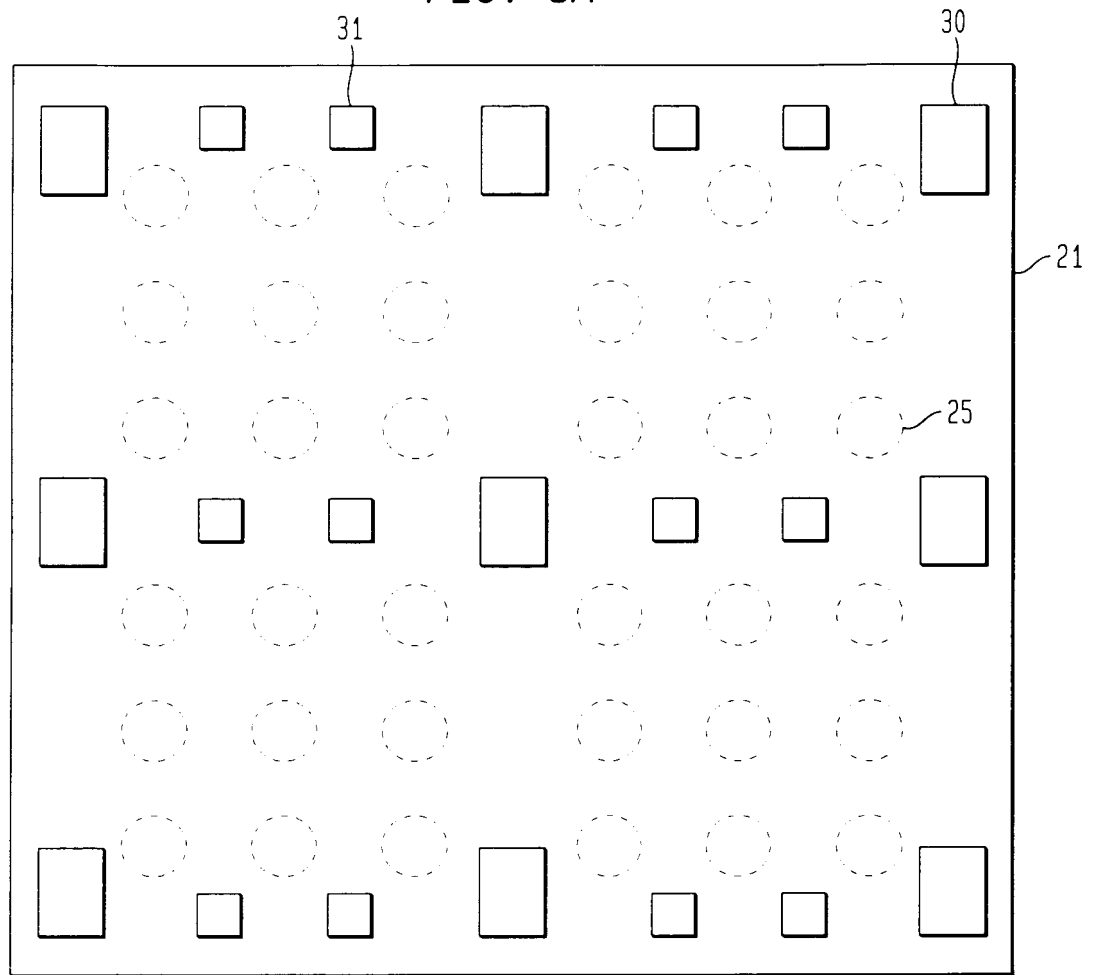


FIG. 3B

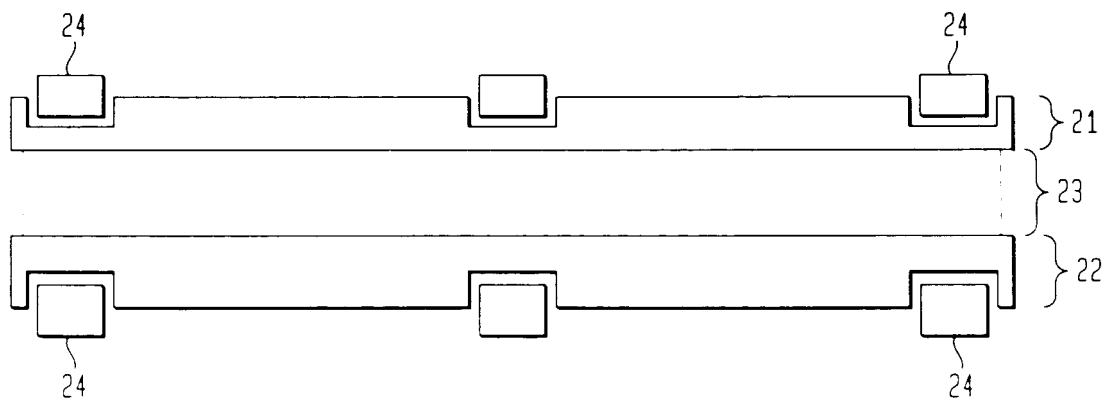


FIG. 4A

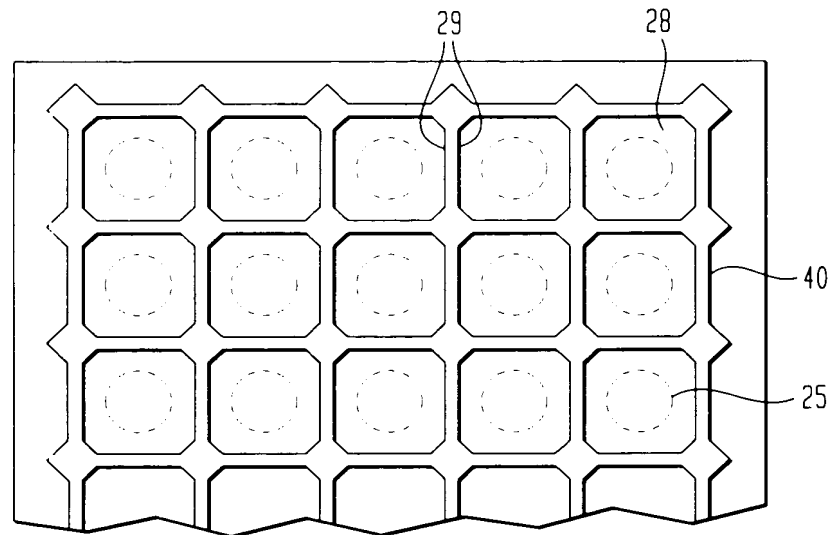


FIG. 4B

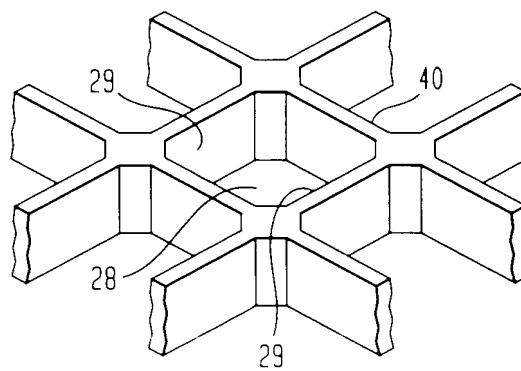


FIG. 5

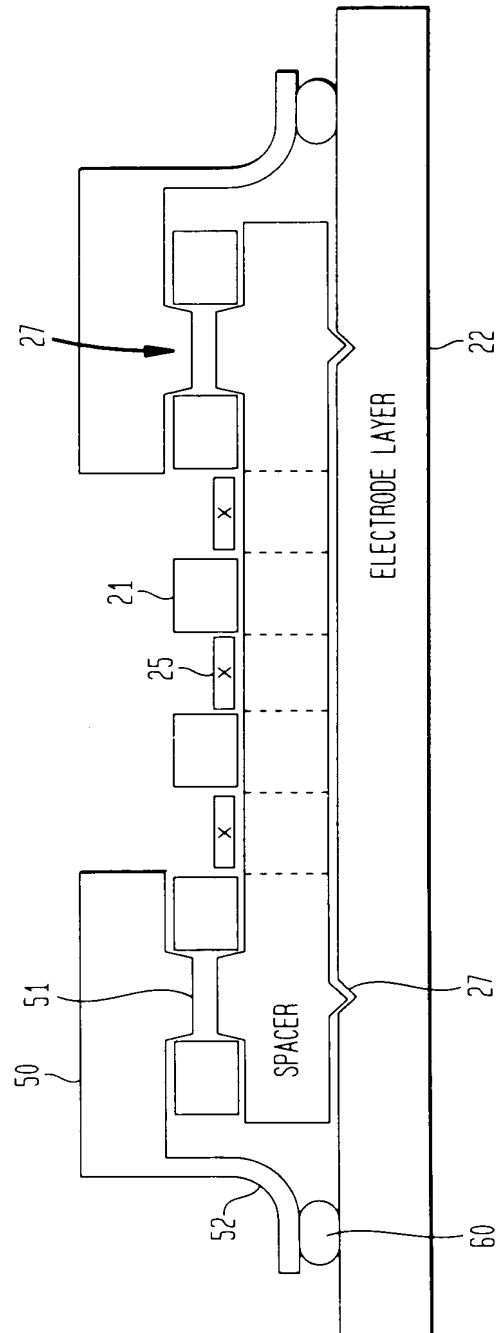


FIG. 6

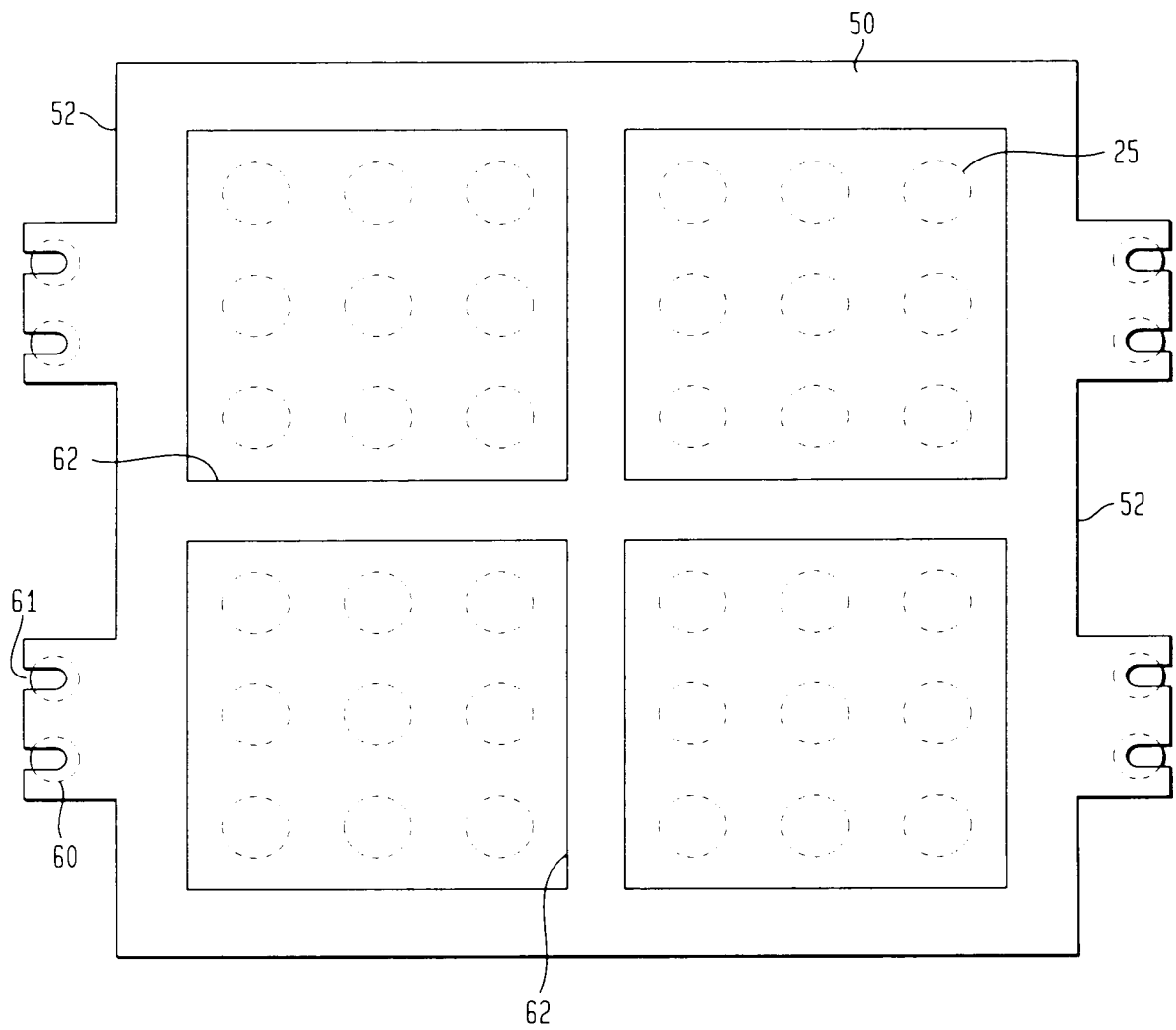


FIG. 7

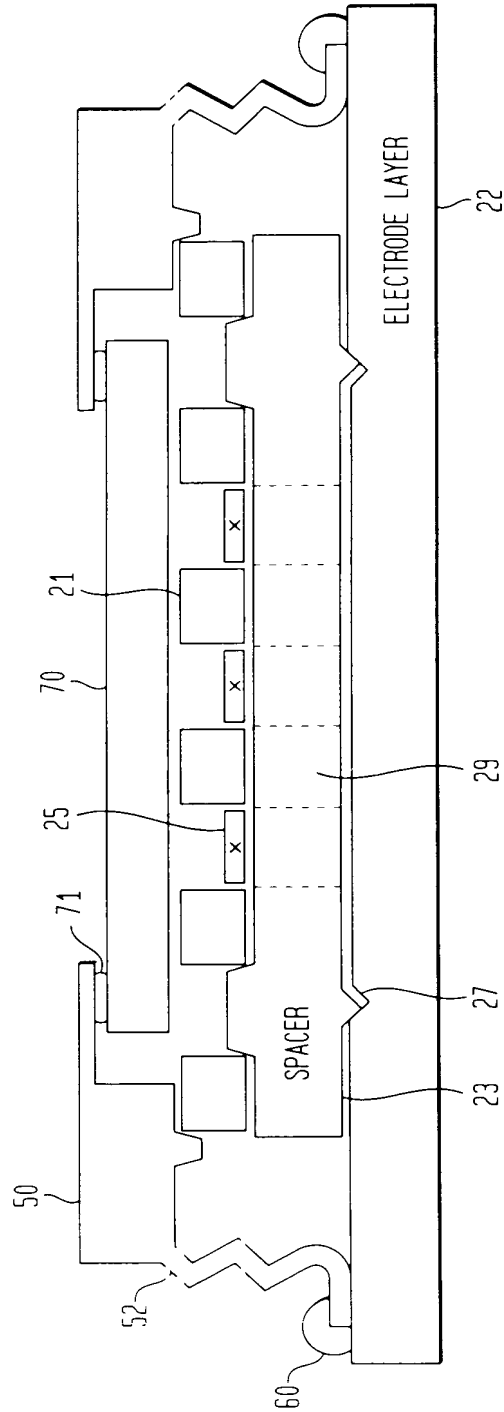


FIG. 8

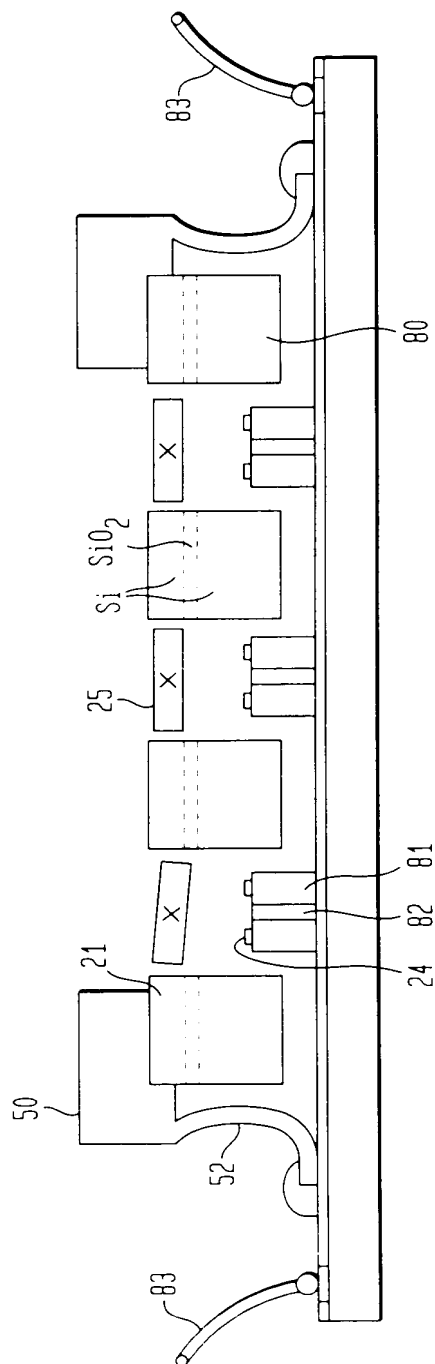


FIG. 9

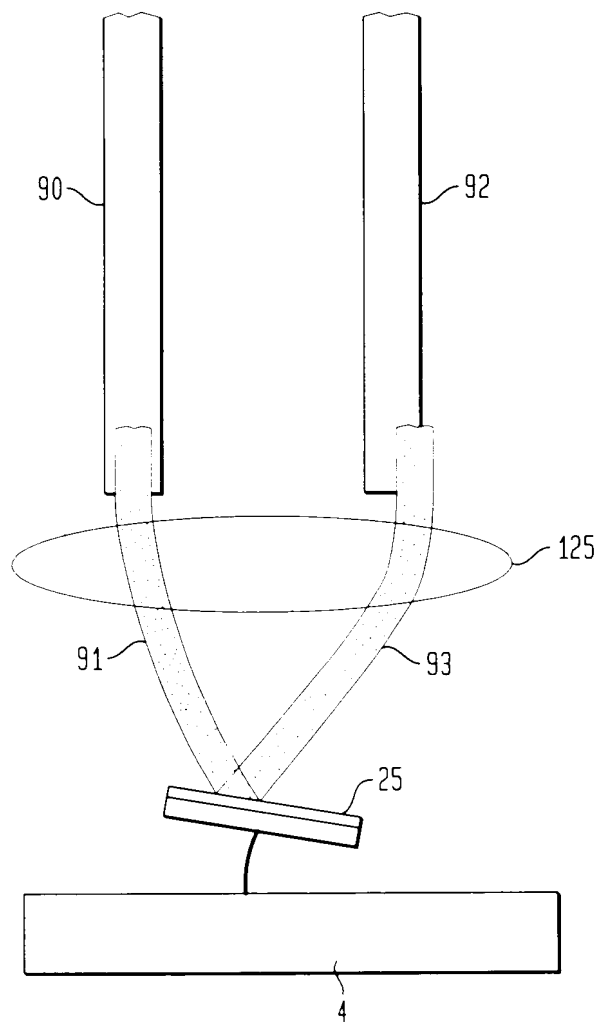


FIG. 10

